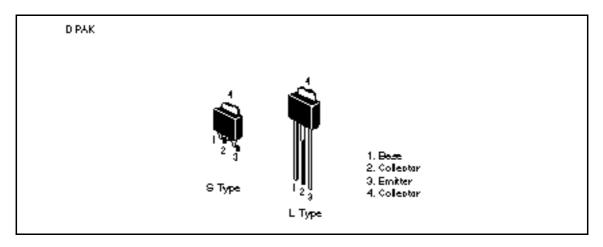
Silicon PNP Epitaxial

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#### Application

Low frequency power amplifier complementary Pair with 2SD2121(L)/(S)

#### Outline





### **Absolute Maximum Ratings** (Ta = $25^{\circ}$ C)

Item	Symbol	Ratings	Unit
Collector to base voltage	V <sub>CBO</sub>	-35	V
Collector to emitter voltage	V <sub>CEO</sub>	-35	V
Emitter to base voltage	V <sub>EBO</sub>	-5	V
Collector current	Ι <sub>c</sub>	-2.5	А
Collector peak current	I <sub>C(peak)</sub>	-3	А
Collector power dissipation	P <sub>c</sub> *1	18	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C
Neter 4 Value et T 2580			

Note: 1. Value at  $T_c = 25^{\circ}C$ .

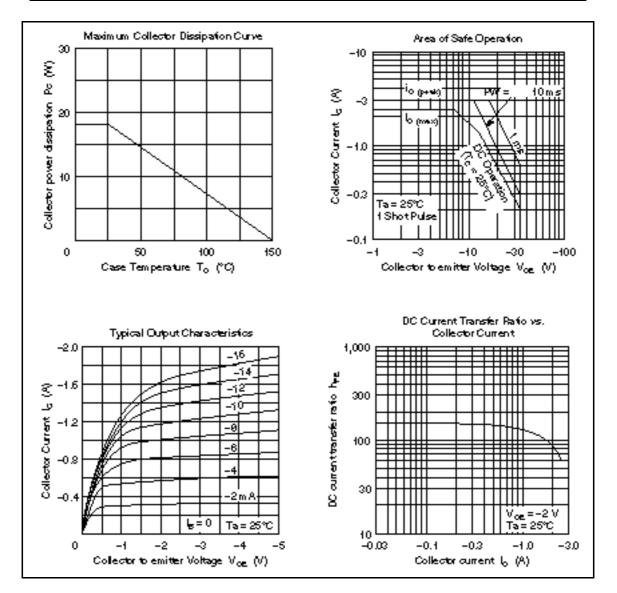
### **Electrical Characteristics** ( $Ta = 25^{\circ}C$ )

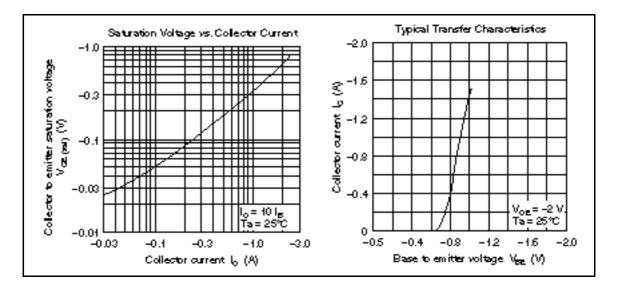
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{\rm (BR)CBO}$	-35	—	—	V	$I_{c} = -1 \text{ mA}, I_{E} = 0$
Collector to emitter breakdown voltage	$V_{\rm (BR)CEO}$	-35	—	—	V	$I_c = -10$ mA, $R_{\scriptscriptstyle BE} =$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	-5	_	_	V	$I_{\rm E} = -1$ mA, $I_{\rm C} = 0$
Collector cutoff current	I <sub>CBO</sub>			-20	μA	$V_{\rm CB} = -35 \ V, \ I_{\rm E} = 0$
DC current transfer ratio	$h_{FE1}^{*1}$	60	_	320		$V_{ce} = -2 \text{ V}, \text{ I}_{c} = -0.5 \text{ A}^{*2}$
	$h_{\text{FE2}}$	20	_	_	_	$V_{ce} = -2 \text{ V}, \text{ I}_{c} = -1.5 \text{ A}^{*2}$
Base to emitter voltage	$V_{BE}$			-1.5	V	$V_{ce} = -2 \text{ V}, \text{ I}_{c} = -1.5 \text{ A}^{*2}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$		_	-1.0	V	$I_{\rm c} = -2$ A, $I_{\rm B} = -0.2$ A <sup>*2</sup>

Notes: 1. The 2SB1407(L)/(S) is grouped by  $h_{FE1}$  as follows.

В	С	D
60 to 120	100 to 200	160 to 320

2. Pulse test.





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